

Description

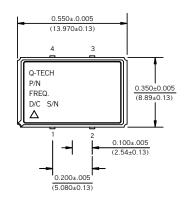
O-Tech's surface-mount OT78 Series oscillators consist of an IC 5Vdc, 3.3Vdc, 2.5Vdc, 1.8Vdc clock square wave generator and a round AT high-precision quartz crystal built in a rugged surface-mount ceramic J-lead miniature package.

Features

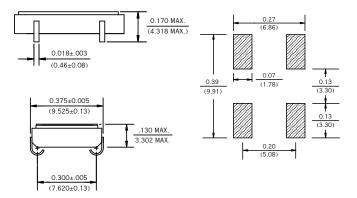
- Made in the USA
- ECCN: EAR99
- DFARS (Berry Amendment) Compliant
- USML Registration # M17677
- Available as OPL MIL-PRF-55310/27, /28, and /30
- Broad frequency range from 15kHz to 150MHz
- Rugged 4 point mount design for high shock and vibration
- ACMOS, HCMOS, TTL or LVHCMOS logic
- Tri-State Output Option (D)
- Hermetically sealed ceramic SMD package
- Fundamental and 3rd Overtone designs
- Low phase noise
- Custom designs available
- Q-Tech does not use pure lead or pure tin in its
- RoHS compliant

Applications

Package Specifications and Outline



Pin No.	Function
1	TRISTATE or NC
2	GND/CASE
3	OUTPUT
4	VDD



Dimensions are in inches (mm)

applications Wide military clock applications

Designed to meet today's requirements for low voltage

- Smart munitions
- Navigation
- Industrial controls
- Microcontroller driver

Package material: 90% AL₂O₃ Lead material: Kovar

Lead finish:

Gold Plated: $60\mu \sim 90\mu$ inches typical

• Nickel Underplate: $100\mu \sim 220\mu$ inches typical

15kHz to 150MHz



Electrical Characteristics

Aging (at 70°C)	Jitter RMS 1σ (at 25°C)	Enable/Disable Tristate function Pin 1	Output Current (Ioh/Iol) ± 24n	Output voltage (Voh/Vol)	Start-up time (Tstup)	Output Load 50pF may for (Fo 30pF may for (Fo	Rise and Fall times (with typical load) (between 1	Symmetry (50% of ouput waveform or 1.4Vdc for TTL)	Operating supply current (1dd) (No Load)	Storage temperature (Tsto)	Operating temperature (Topr)	Frequency stability ($\Delta F/\Delta T$)	Supply voltage (Vdd)	Output frequency range (Fo)	Parameters Q17		
\pm 5ppm max. first year / \pm 2ppm max. per year thereafter	8ps typ < 40MHz 5ps typ ≥ 40MHz	$ VIH \geq 2.2V \ Oscillation; $ $ VIL \leq 0.8V \ High \ Impedance $	V	V	± 24mA max. ± 8mA max.	0.9 x Vdd min.; 0.1 x Vdd max.		1SpF // 10kohms 1SpF // 10kohms 50pF max. or 10TTL for (Fo < 60MHz)	(Hz 7ns 5MHz 3ns m %) (be	$45/55\%$ max 15 kHz \sim < 15 MHz $40/60\%$ max $15 \sim \leq 85$ MHz (Tighter symmetry available)	20 mA max 15kHz ~ < 16MHz 25 mA max 16MHz ~ < 32MHz 35 mA max 32MHz ~ < 60MHz 45 mA max 60MHz ~ ≤ 85MHz				$5.0 \text{Vdc} \pm 10\%$	$15 \mathrm{kHz} - 85.000 \mathrm{MHz}$ (*)	Q1/8AC Q1/8HC
			-1.6 mA/TTL +40 μA/TTL	2.4V min.; 0.4V max.		10TTL (Fo < 60MHz) 6TTL (Fo ≥ 60MHz)	3ns	: 15MHz IsMHz lable)	: 16MHz < 32MHz < 60MHz <u><</u> 85MHz					z (*)	Q1/81		
	15ps typ < 40MHz 8ps typ ≥ 40MHz	$VIH \ge 0.7 \times V$ $VIL \le 0.3 \times V dd$					5ms max.	15pF // 10kohms (30pF max. for $F \le 50MHz$)	6ns max 15kHz \sim < 40MHz 3ns max 40 \sim ≤ 150MHz (between 10% to 90%)	$45/55\%$ max 15 kHz \sim < 15 MHz $40/60\%$ max $15 \sim \le 150$ MHz (Tighter symmetry available)	3 mA max 15kHz ~ < 500kHz 6 mA max 500kHz ~ < 16MHz 10 mA max 16MHz ~ < 32MHz 20 mA max 16MHz ~ < 60MHz 30 mA max 32MHz ~ < 60MHz 40 mA max 100MHz ~ < 110MHz 40 mA max 1100MHz ~ < 110MHz	-62°C to + 125°C	See Option codes	See Option codes	$3.3 \text{Vdc} \pm 10\%$	15kHz — 150.000MHz (*)	Q1/8F
			$VIH \ge 0.7 \times V$ $VIL \le 0.3 \times Vdd$	$VIH \ge 0.7 \times V$ $VIL \le 0.3 \times Vdd$	± 4mA max.	0.9 x Vdd min.; 0.1 x Vdd max.		15pF // 10kohms	5ns max 125kHz ~< 40MHz 3ns max 40 ~≤ 133MHz (between 10% to 90%)	$45/55\%$ max 125 kHz \sim < 15 MHz $40/60\%$ max $15 \sim \le 133$ MHz (Tighter symmetry available)	3 mA max 125kHz ~< 500kHz 6 mA max 500kHz ~< 40MHz 15 mA max 500kHz ~< 60MHz 15 mA max 40MHz ~< 60MHz 25 mA max 60MHz ~< 85MHz 35 mA max 85MHz ~ 133MHz				$2.5 \text{Vdc} \pm 10\%$	125.000kHz — 133.000MHz	Q1/8N
						VIH ≥ 0.7 x Vdd Oscillation; VIL ≤ 0.3 x Vdd High Impedance				(0 koh ms	5ns max 125kHz \sim 40MHz 3ns max 40 \sim 5100MHz (between 10% to 90%)	45/55% max 125kHz~< 15MHz 40/60% max 15 ~≤ 100MHz (Tighter symmetry available)	4 mA max125kHz ~< 40MHz 10 mA max40MHz ~< 50MHz 20 mA max50MHz ~< 85MHz 25 mA max85MHz ~≤ 100MHz				1.8Vdc ± 10%

(*) Frequency as low as 1kHz without tristate function available. Contact Q-Tech for details.

Q-TECH Corporation

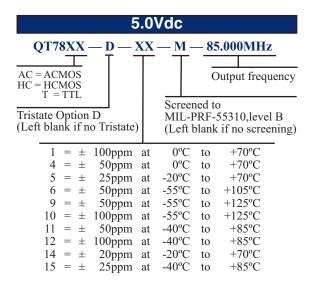
10150 W. Jefferson Boulevard, Culver City 90232

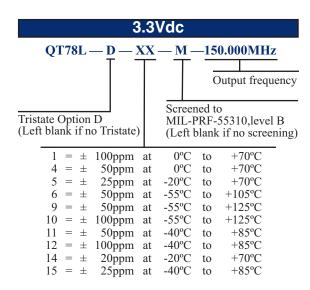
Tel: 310-836-7900 - Fax: 310-836-2157

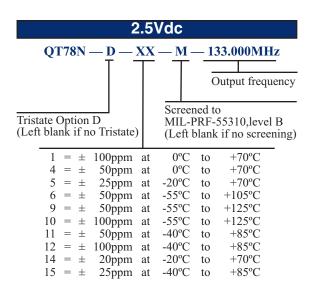
www.q-tech.com

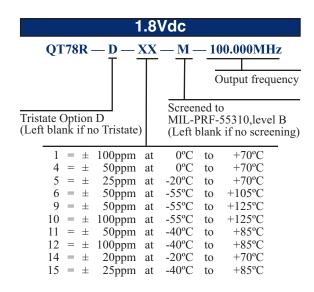


Ordering Information









Frequency stability vs. temperature codes may not be available in all frequencies.

For Non-Standard requirements, contact Q-Tech Corporation at Sales@Q-Tech.com

Packaging Options

- Standard packaging in anti-static plastic tube (60pcs/tube)
- Tape and Reel (800pcs/reel) is available for an additional charge.

Other Options Available For An Additional Charge

- Solder Dip Sn/Pb 60/40%
- P. I. N. D. test

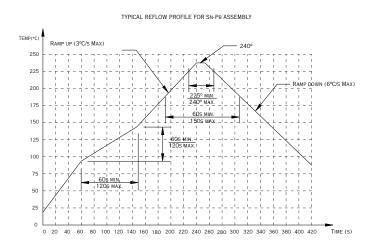
Specifications subject to change without prior notice.



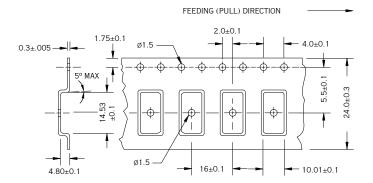
Reflow Profile

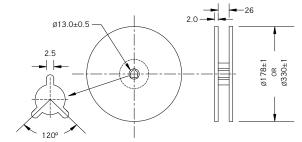
The five transition periods for the typical reflow process are:

- Preheat
- Flux activation
- Thermal equalization
- · Reflow
- · Cool down



Embossed Tape and Reel Information For QT78





Dimensions are in mm. Tape is compliant to EIA-481-A.

Reel size vs. quantity:

Reel size (Diameter in mm)	Qty per reel (pcs)				
178	250				
330	1000				

Environmental Specifications

Q-Tech Standard Screening/QCI (MIL-PRF55310) is available for all of our QT78 Products. Q-Tech can also customize screening and test procedures to meet your specific requirements. The QT78 product is designed and processed to exceed the following test conditions:

Environmental Test	Test Conditions
Temperature cycling	MIL-STD-883, Method 1010, Cond. B.
Constant acceleration	MIL-STD-883, Method 2001, Cond. A, Y1.
Seal Fine Leak	MIL-STD-883, Method 1014, Cond. A.
Burn-in	160 hours, 125°C with load.
Aging	30 days, 70°C, ±1.5ppm max.
Vibration sinusoidal	MIL-STD-202, Method 204, Cond. D.
Shock, non operating	MIL-STD-202, Method 213, Cond. I. (See Note 1)
Thermal shock, non operating	MIL-STD-202, Method 107, Cond. B.
Ambient pressure, non operating	MIL-STD-202, 105, Cond. C, 5 minutes dwell time minimum.
Resistance to solder heat	MIL-STD-202, Method 210, Cond. E.
Moisture resistance	MIL-STD-202, Method 106.
Terminal strength	MIL-STD-202, Method 211, Cond. C.
Resistance to solvents	MIL-STD-202, Method 215.
Solderability	MIL-STD-202, Method 208.

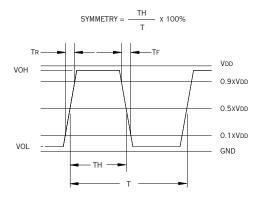
Note 1: Additional shock results successfully passed on 16MHz, 40MHz, and 80MHz

- Shock 850g peak, half-sine, 1 ms duration (MIL-STD-202, Method 213, Cond. D modified)
- Shock 1,500g peak, half-sine, 0.5ms duration (MIL-STD-883, Method 2002, Cond. B)

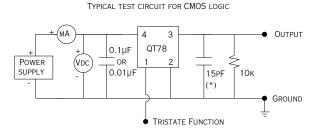
Please contact Q-Tech for higher shock requirements



Output Waveform (Typical)



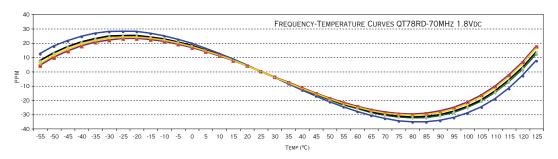
Test Circuit



(*) $\operatorname{\mathsf{CL}}$ includes probe and Jig capacitance

The Tristate function on pin 1 has a built-in pull-up resistor typical $50k\Omega$, so it can be left floating or tied to Vdd without deteriorating the electrical performance.

Frequency vs. Temperature Curve



Thermal Characteristics

The heat transfer model in a hybrid package is described in figure 1.

Heat spreading occurs when heat flows into a material layer of increased cross-sectional area. It is adequate to assume that spreading occurs at a 45° angle.

The total thermal resistance is calculated by summing the thermal resistances of each material in the thermal path between the device and hybrid case.

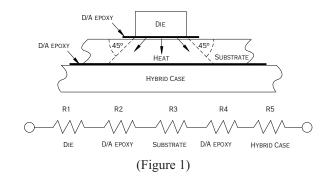
$$RT = R1 + R2 + R3 + R4 + R5$$

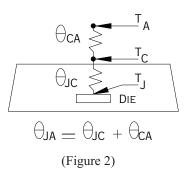
The total thermal resistance RT (see figure 2) between the heat source (die) to the hybrid case is the Theta Junction to Case (Theta JC) in °C/W.

- Theta junction to case (Theta JC) for this product is 30°C/W.
- Theta case to ambient (Theta CA) for this part is 100°C/W.
- Theta Junction to ambient (Theta JA) is 130°C/W.

Maximum power dissipation PD for this package at 25°C is:

- PD(max) = (TJ(max) TA)/Theta JA
- With TJ = 175°C (Maximum junction temperature of die)
- PD(max) = (175 25)/130 = 1.15W

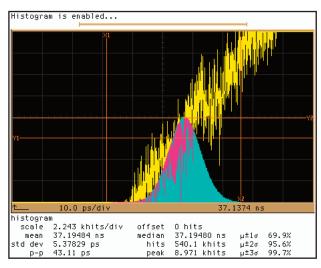






Period Jitter

As data rates increase, effects of jitter become critical with its budgets tighter. Jitter is the deviation of a timing event of a signal from its ideal position. Jitter is complex and is composed of both random and deterministic jitter components. Random jitter (RJ) is theoretically unbounded and Gaussian in distribution. Deterministic jitter (DJ) is bounded and does not follow any predictable distribution. DJ is also referred to as systematic jitter. A technique to measure period jitter (RMS) one standard deviation (1σ) and peak-to-peak jitter in time domain is to use a high sampling rate (>8G samples/s) digitizing oscilloscope. Figure shows an example of peak-to-peak jitter and RMS jitter (1σ) of a QT78AC-24MHz, at 5.0Vdc.



RMS jitter (1σ) : 5.37ps

Peak-to-peak jitter: 43ps

Phase Noise and Phase Jitter Integration

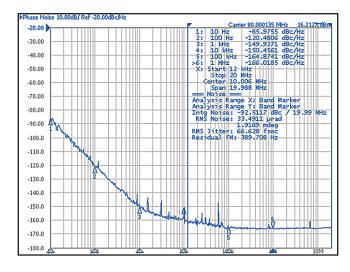
Phase noise is measured in the frequency domain, and is expressed as a ratio of signal power to noise power measured in a 1Hz bandwidth at an offset frequency from the carrier, e.g. 10Hz, 100Hz, 1kHz, 10kHz, 100kHz, etc. Phase noise measurement is made with an Agilent E5052A Signal Source Analyzer (SSA) with built-in outstanding low-noise DC power supply source. The DC source is floated from the ground and isolated from external noise to ensure accuracy and repeatability.

In order to determine the total noise power over a certain frequency range (bandwidth), the time domain must be analyzed in the frequency domain, and then reconstructed in the time domain into an rms value with the unwanted frequencies excluded. This may be done by converting L(f) back to $S\phi(f)$ over the bandwidth of interest, integrating and performing some calculations.

Symbol	Definition				
∫L(f)	Integrated single side band phase noise (dBc)				
S\phi(f)=(180/\Pi)x\sqrt{2}\int L(f)df	Spectral density of phase modulation, also known as RMS phase error (in degrees				
RMS jitter = $S\phi$ (f)/(fosc.360°)	Jitter(in seconds) due to phase noise. Note Sφ (f) in degrees.				

The value of RMS jitter over the bandwidth of interest, e.g. 10kHz to 20MHz, 10Hz to 20MHz, represents 1 standard deviation of phase jitter contributed by the noise in that defined bandwidth.

Figure below shows a typical Phase Noise/Phase jitter of a QT78AC6, 5.0Vdc, 80MHz clock at offset frequencies 10Hz to 5MHz, and phase jitter integrated over the bandwidth of 12kHz to 1MHz.



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